PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WUFENG DENG	07/24/2014

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14445867	

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NAME OF SUBMITTER:	MENG LIU
SIGNATURE:	/Meng Liu/

502912501 REEL: 033414 FRAME: 0423

DATE SIGNED: 07/29/2014

Total Attachments: 2
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PATENT REEL: 033414 FRAME: 0424 SMIC 2013-01595-SH-US Anova Law Group, PLLC 00158.0187.00US US Rights Page 1

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WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:

CHEMICAL MECHANICAL PLANARIZATION APPARATUS AND METHODS

			Letters Patent concur (Application No	rrently herewith or filed an
of P. R. China Development An International (Sh Zhangjiang Road desirous of secu- the world, and in	whose post office add ea, Daxing District, Be anghai) Corporation. I, Pudong New Area, ring the entire right, tit	tress is <u>No. 18, Waijing, China 1007</u> a corporation of <u>P</u> <u>Shanghai, China 2</u> tle, and interest in a for United States	en Chang Rd. Econor [6, and <u>Semiconducto</u> <u>R. China</u> whose post 201203 (hereinafter re and to this invention in	r Manufacturing

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HER	REBY authorize and request the attorneys I/we have empowered in the	
Declaration and Power	of Attorney in this application, to insert here in parentheses (Application No	
filed) the filing date and application number of said application when known.	

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IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor:

Name:

WUFENG DENG

Address:

18 Zhangjiang Road, Pudong New Area

Shanghai, China 201203

Signature:

waters Reg

Date:

2014.07.24

RECORDED: 07/29/2014